#### 502190688 01/10/2013

## PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Kenji Enokido	11/29/2012

## **RECEIVING PARTY DATA**

Name:	THE YOKOHAMA RUBBER CO., LTD.
Street Address:	36-11, Shimbashi 5-chome
City:	Minato-ku, Tokyo
State/Country:	Japan
Postal Code:	105-8685

## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13809518

#### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: FPS-0005

NAME OF SUBMITTER: Lee Cheng

Total Attachments: 1

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CH \$40.00

PATENT REEL: 029605 FRAME: 0933

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Docket No.	

# U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable ration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by

	consideration paid to the undersigned inv	entor(s) (hereinafter ASSIGNOR) by	ý	
Insert ASSIGNEE's	The Yokohama Rubber Co., Ltd.			
lame(s) address(es)]	of 36-11, Shimbashi 5-chome, Minat	o-ku, Tokyo 105-8685, JAPAN		
	(hereinafter ASSIGNEE), the receipt of hereby sells, assigns and transfers to A entitled	which is hereby acknowledged, the ASSIGNEE all of the right, title an	e undersigned ASSIGNOR d interest to the invention	
Fitle of nvention]	METHOD OF PRODUCING TIRE VULCANIZATION MOLD, AND TIRE VULCANIZATION MOLD			
*If the assignment being filed fter the filing of the	for which application for Letters Patent otherwise indicated below:	of the United States was executed or	n even date herewith unless	
pplication, this action must be	*filed on	, Serial No.		
ompleted]	(Cheng Law Group, PLLC is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)			
	and all Letters Patent of the United State division, renewal, substitute, reissue or same may be granted.			
	The ASSIGNOR agrees to exec continuing, divisional, reissue or reex assignments in connection with such app		also to execute separate	
	The ASSIGNOR agrees to exe litigation, or other legal proceeding continuation, division, reissue or reexam and to cooperate with the ASSIGNEE is proceeding with such interference, litigat	ination thereof or Letters Patent or ren n every way possible in obtaining a	g this application or any eissue patent issued thereon	
	IN WITNESS WHEREOF, the undersign	ned inventor(s) has (have) affixed his	/her/their signature(s).	
Signature(s) f Assignor(s)]	Kenji Enokido	Kenji ENOKIDO	November 29, 2012	
( / ISSIENO ( 3 ) ]	(SIGNATURE)	(TYPE NAME)	(DATE)	
	(SIGNATURE)	(TYPE NAME)	(DATE)	
	(SIGNATURE)	(TYPE NAME)	(DATE)	
	(SIGNATURE)	(TYPE NAME)	(DATE)	

**PATENT** REEL: 029605 FRAME: 0934

**RECORDED: 01/10/2013**